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FACSIMILE COVER SHEET

To Examiner: Jeffrey C. Mullis	Total Pages Sent: 11
Mail Stop: Amendment	(including cover sheet)
Facsimile Number: 571-273-8300	Transmission Date: October 10, 2005

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Hsu, <i>et al.</i>	Docket No.: TSM02-1205
Serial No: 10/615,628	Art Unit: 1711
Date Filed: July 9, 2003	
Title: Process for Improving Dielectric Properties in Low-K Organosilicate Dielectric Material	

CERTIFICATION OF FACSIMILE TRANSMISSION

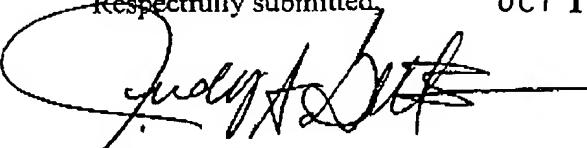
I hereby certify that the following papers are being transmitted by facsimile to the U.S. Patent and Trademark Office at 571-273-8300 on the date shown above:

- Certification of Facsimile Transmission (1 page)
- Amendment (8 pages)
- Amendment Transmittal Letter (1 original & 1 copy)

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Respectfully submitted,

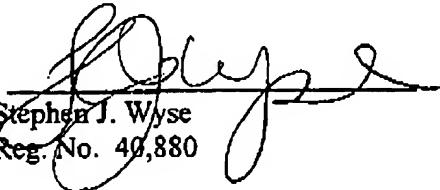
OCT 11 2005


 Judy A. Betts
 Legal Assistant

Confirmation Respectfully Requested

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OCT 10 2005

AMENDMENT TRANSMITTAL LETTER				Attorney Docket No: TSM02-1205		
Application Serial Number: 10/615,628	Filing Date: 7/9/2003		Examiner: Jeffrey C. Mullis		Art Unit: 1711	
Invention: Process for Improving Dielectric Properties in Low-K Organosilicate Dielectric Material						
TO THE COMMISSIONER FOR PATENTS: Transmitted herewith is an amendment in the above-identified application. The fee has been calculated as shown below.						
CLAIMS AS AMENDED						
	CLAIMS REMAINING AFTER AMENDMENT		HIGHEST NUMBER PREVIOUSLY PAID FOR	NO. OF EXTRA CLAIMS PRESENT	RATE	ADDITIONAL FEE
TOTAL CLAIMS	14	MINUS	20	0	\$50	\$ 0.00
INDEP. CLAIMS	5	MINUS	4	1	\$200	\$ 200.00
<p>— Petition is hereby made under 37 CFR 1.136(a) to extend the time for response to the Office Action of _____ to and through _____, comprising an extension of the shortened statutory period of:</p> <p>— one month (\$120.00) — three months (\$1,020.00) — two months (\$450.00) — four months (\$1,590.00)</p>						
TOTAL ADDITIONAL FEE FOR THIS AMENDMENT						
<p>— Small entity status of this application under 37 CFR 1.9 and 1.27 has been established by a verified statement previously submitted.</p> <p>— A verified statement to establish small entity status under 37 CFR 1.9 and 1.27 is enclosed.</p> <p>— A check in the amount of \$_____ is attached.</p> <p><u>X</u> Charge \$200.00 to Deposit Account 50-1065.</p> <p>— No additional fee is required.</p>						
<u>October 10, 2005</u> date						
 Stephen J. Wyse Reg. No. 40,880						

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Hsu, *et al.* Docket No.: TSM02-1205

Serial No.: 10/615,628 Art Unit: 1711

Filed: July 9, 2003 Examiner: Jeffrey C. Mullis

Title: Process for Improving Dielectric Properties in Low-K Organosilicate Dielectric Material

Mail Stop: Amendment
Commissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

Dear Sir:

The following amendments and remarks are presented in response to the Examiner's Office Action mailed July 14, 2005. Please amend the above-referenced application as follows.

10/12/2005 EFLORES 00000018 501065 10615628

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TSM02-1205

Page 1 of 8

Amendment